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N-Channel POWERTRENCH® MOSFET

100 V, 80 A, 6.4 mΩ

Features

- Typ $R_{DS(on)} = 5.2 \text{ m}\Omega$ at $V_{GS} = 10 \text{ V}$, $I_D = 80 \text{ A}$
- Typ $Q_{g(tot)} = 31 \text{ nC}$ at $V_{GS} = 10 \text{ V}$, $I_D = 80 \text{ A}$
- UIS Capability
- Qualified to AEC Q101
- Wettable flanks for automatic optical inspection (AOI)
- These Devices are Pb-Free and are RoHS Compliant

Applications

- Automotive Engine Control
- Powertrain Management
- Solenoid and Motor Drivers
- Electronic Steering

Symbol	Parameter	Ratings	Unit			
V _{DSS}	Drain to Source Voltage	100	V			
V _{GS}	Gate to Source Voltage	±20	V			
Ι _D	Drain Current (T _C = 25°C) Continuous (V _{GS} = 10 V) (Note 1) Pulsed	80 (see Fig. 4)	A			
E _{AS}	Single Pulse Avalanche Energy (Note 2)	36	mJ			
P _D	Power Dissipation Derate above 25°C	214 1.43	W W/°C			
T _J , T _{STG}	Operating and Storage Temperature	–55 to +150	°C			
$R_{\theta JC}$	Thermal Resistance (Junction to case)	0.7	°C/W			
$R_{ hetaJA}$	Maximum Thermal Resistance (Junction to Ambient) (Note 3)	50	°C/W			

MOSFET MAXIMUM RATINGS ($T_A = 25^{\circ}C$, Unless otherwise specified)

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

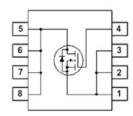


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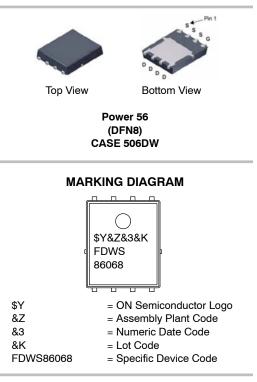
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V _{DSS}	I _D MAX	R _{DS(on)} MAX
100 V	80 A	6.4 mΩ

ELECTRICAL CONNECTION



N-Channel MOSFET



ORDERING INFORMATION

See detailed ordering and shipping information on page 2 of this data sheet.

PACKAGE MARKING AND ORDERING INFORMATION

Device Marking	Device	Package	Reel Size	Tape Width	Quantity	
FDWS86068	FDWS86068-F085	Power 56	13″	12 mm	3,000 Units	

NOTES:

1. Current is limited by wirebond configuration.

2. Starting $T_J = 25^{\circ}$ C, L = 20 μ H, I_{AS} = 60 A, V_{DD} = 80 V during inductor charging and V_{DD} = 0 V during time in avalanche. 3. R_{0JA} is the sum of the junction–to–case and case–to–ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins. $R_{\theta JC}$ is guaranteed by design while $R_{\theta JA}$ is determined by the user's board design. The maximum rating presented here is based on mounting on a 1 in2 pad of 2oz copper.

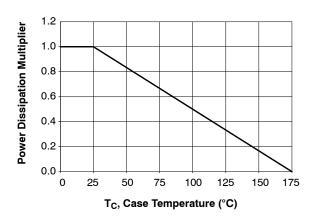
ELECTRICAL CHARACTERISTICS (T_J = 25°C unless otherwise noted)

Symbol	Parameter	Test Conditions	Min	Тур	Max	Unit
FF CHARAC	TERISTICS					
B _{VDSS}	Drain to Source Breakdown Voltage	$I_D = 250 \ \mu A, \ V_{GS} = 0 \ V$	100	-	-	V
I _{DSS}	Drain to Source Leakage Current	$V_{DS} = 100 \text{ V}, V_{GS} = 0 \text{ V}$ (T _J = 25°C) (T _J = 175°C) (Note 4)			1 1	μA mA
I _{GSS}	Gate to Source Leakage Current	$V_{GS} = \pm 20 \text{ V}$	-	-	±100	nA
N CHARACT	ERISTICS					
V _{GS(th)}	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_D = 250 \ \mu A$	2	3	4	V
R _{DS(on)}	Drain to Source On Resistance			5.2 11.4	6.4 14	mΩ
YNAMIC CHA	ARACTERISTICS					
C _{iss}	Input Capacitance	V _{DS} = 50 V, V _{GS} = 0 V, f = 1 MHZ	-	2220	-	pF
C _{oss}	Output Capacitance		-	1350	-	pF
C _{rss}	Reverse Transfer Capacitance		-	19	-	pF
Rg	Gate Resistance	V _{GS} = 0.5 V, f = 1 MHz	-	0.3	-	Ω
Q _{g(tot)}	Total Gate Charge	V_{GS} = 0 $$ to 10 V, V_{DD} = 50 V, I_{D} = 80 A $$	-	31	43	nC
Q _{g(th)}	Threshold Gate Charge	V_{GS} = 0 to 2 V, V_{DD} = 50 V, I_{D} = 80 A	-	4	-	nC
Q _{gs}	Gate to Source Gate Charge	V _{DD} = 50 V, I _D = 80 A	-	12	-	nC
Q _{gd}	Gate to Drain "Miller" Charge		-	7	-	nC
WITCHING C	HARACTERISTICS					
t _{on}	Turn-On Time	V_{DD} = 50 V, I_{D} = 80 A, V_{GS} = 10 V, R_{GEN} = 6 Ω	-	-	30	ns
t _{d(on)}	Turn-On Delay Time		-	15	-	ns
t _r	Turn-On Rise Time		-	6	-	ns
t _{d(off)}	Turn-Off Delay Time		-	24	-	ns
t _f	Turn-Off Fall Time		-	7	-	ns
t _{off}	Turn-Off Time		-	-	48	ns
RAIN-SOURC	E DIODE CHARACTERISTICS					
V_{SD}	Source to Drain Diode Forward Voltage	$I_{SD} = 80 \text{ A}, \text{ V}_{GS} = 0 \text{ V}$	-	0.95	1.3	V
		$I_{SD} = 40 \text{ A}, \text{ V}_{GS} = 0 \text{ V}$	-	0.87	1.2	V
T _{rr}	Reverse Recovery Time	I _F = 80 A, dI _{SD} /dt = 100 A/μs	-	61	80	ns
Q _{rr}	Reverse Recovery Charge	1	-	56	84	nC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. 4. The maximum value is specified by design at $T_J = 175^{\circ}$ C. Product is not tested to this condition in production

TYPICAL CHARACTERISTICS

(T_J = 25°C unless otherwise noted)





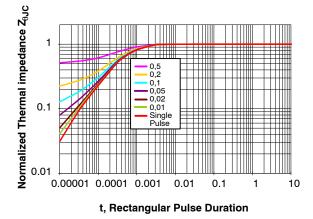


Figure 3. Normalized Maximum Transient Thermal Impedance

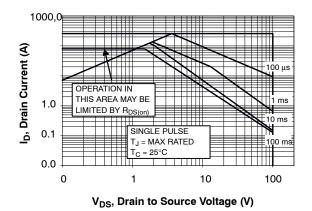


Figure 5. Forward Bias Safe Operating Area

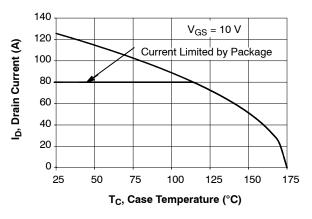


Figure 2. Maximum Continuous Drain Current vs. Case Temperature

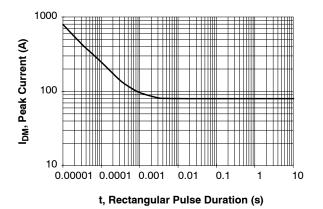
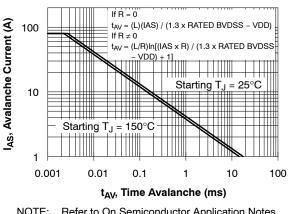


Figure 4. Peak Current Capability

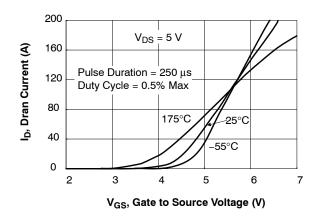


NOTE: Refer to On Semiconductor Application Notes AN7514 and AN7515

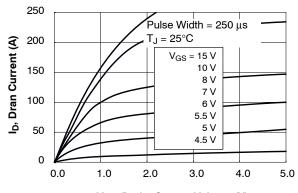
Figure 6. Unclamped Inductive Switching Capability

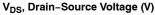
TYPICAL CHARACTERISTICS

(T_J = 25°C unless otherwise noted)











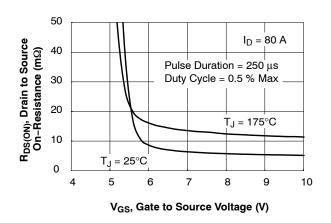


Figure 11. R_{DSON} vs. Gate Voltage

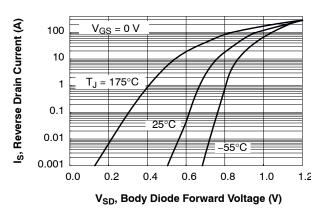


Figure 8. Forward Diode Characteristics

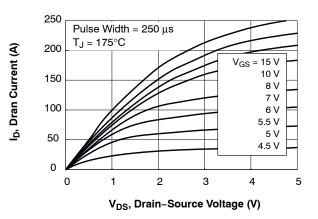
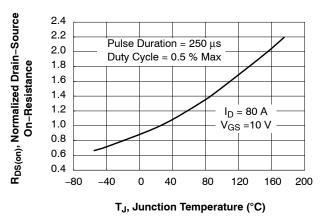


Figure 10. Peak Current Capability





TYPICAL CHARACTERISTICS

(T_J = 25°C unless otherwise noted)

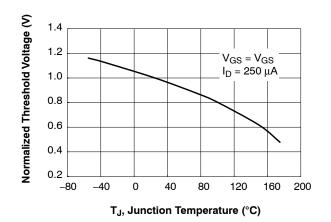


Figure 13. Normalized Gate Threshold Voltage vs. Temperature

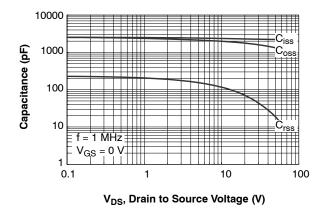


Figure 15. Capacitance vs. Drain to Source Voltage

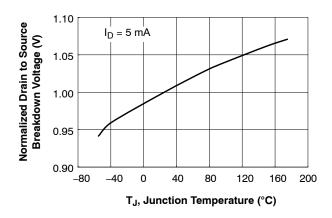


Figure 14. Normalized Drain to Source Breakdown Voltage vs. Junction Temperature

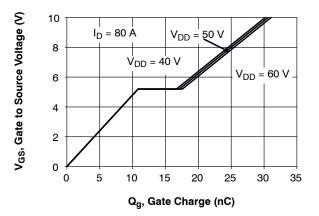


Figure 16. Gate Charge vs. Gate to Source Voltage

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